

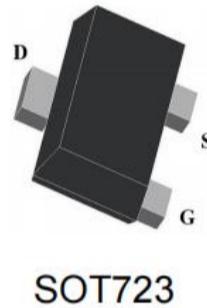
### Features

- Lead free product is acquired
- Surface mount package
- P-Channel switch with low  $R_{DS(on)}$
- Operated at low logic level gate drive
- ESD protected gate
- Complementary to TPM2018EX3

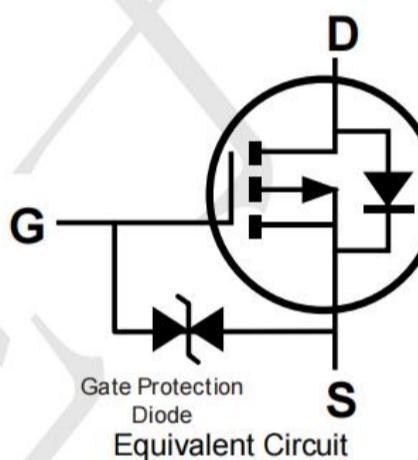
### Application

- Load/Power Switching
- Interfacing Switching
- Battery Management for Ultra Small Portable Electronics
- Logic Level Shift

### Package and Pin Configuration



SOT723



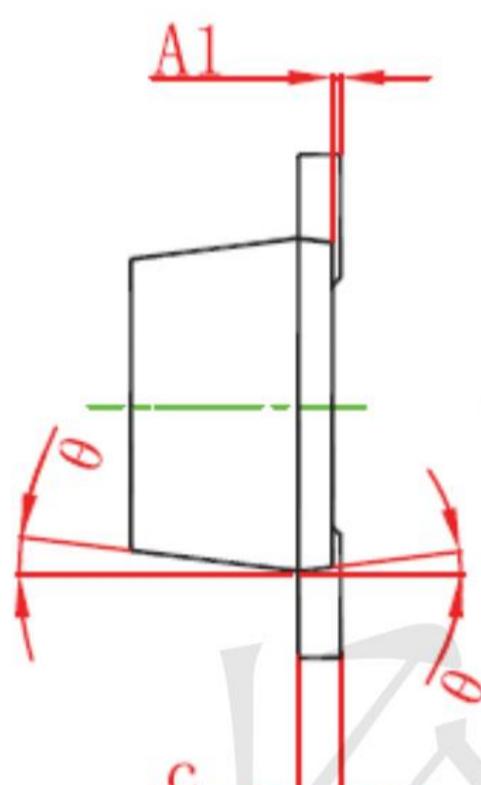
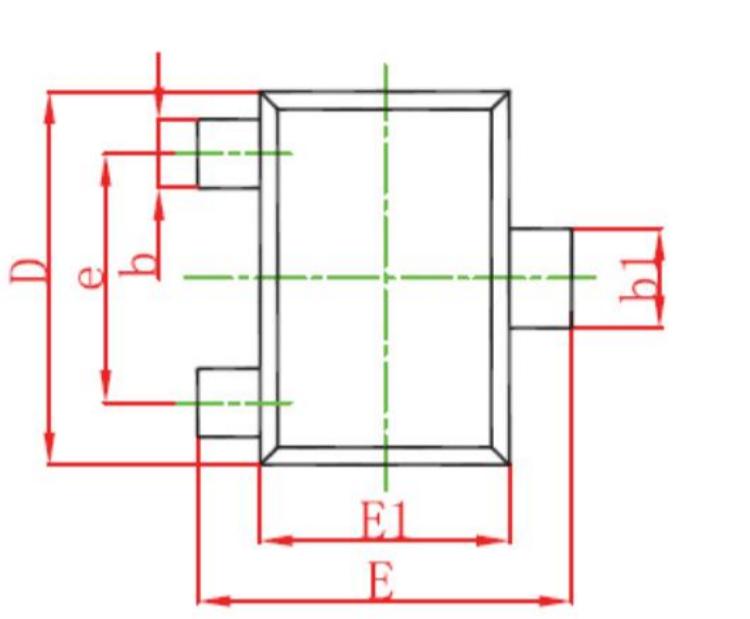
### Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-source voltage	$V_{DS}$	-20	V
Typical gate-source voltage	$V_{GS}$	$\pm 12$	V
Continuous drain current (note 1)	$I_D$	-0.66	A
Pulsed drain current ( $t_p=10\mu\text{s}$ )	$I_{DM}$	-1.2	A
Power dissipation (note 2)	$P_D$	100	mW
Thermal resistance from junction to ambient (note 1)	$R_{GJA}$	1250	$^\circ\text{C}/\text{W}$
Junction temperature range	$T_J$	150	$^\circ\text{C}$
Storage temperature range	$T_{STG}$	-55 ~ +150	$^\circ\text{C}$
Lead temperature for soldering purposes (1/8" from case for 10s)	$T_L$	260	$^\circ\text{C}$

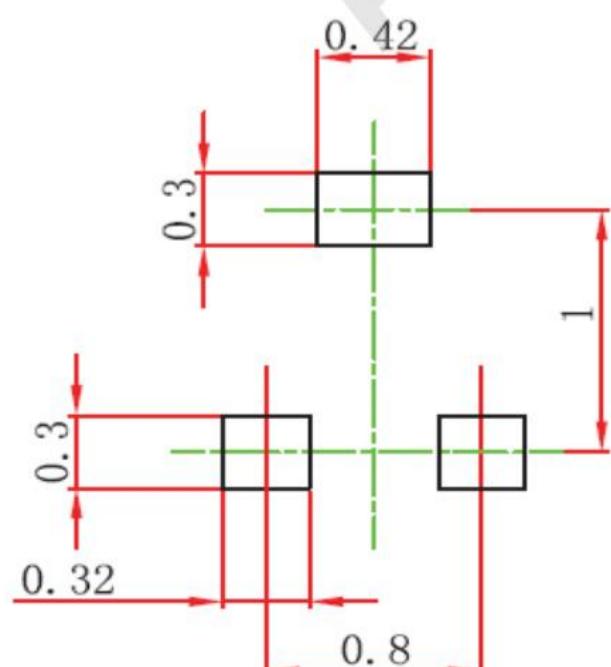
**Electrical Characteristics (  $T_A = 25^\circ\text{C}$  unless otherwise noted )**

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
<b>STATIC PARAMETERS</b>						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}$ , $I_D = -250\mu\text{A}$	-20			V
Zero gate voltage drain current	$I_{\text{DSS}}$	$V_{\text{DS}} = -20\text{V}$ , $V_{\text{GS}} = 0\text{V}$			-1	$\mu\text{A}$
Gate-body leakage current	$I_{\text{GSS}}$	$V_{\text{GS}} = \pm 10\text{V}$ , $V_{\text{DS}} = 0\text{V}$			$\pm 20$	$\mu\text{A}$
Gate threshold voltage (note 2)	$V_{\text{GS(th)}}$	$V_{\text{DS}} = V_{\text{GS}}$ , $I_D = -250\mu\text{A}$	-0.35		-1.1	V
Drain-source on-resistance (note 2)	$R_{\text{DS(on)}}$	$V_{\text{GS}} = -4.5\text{V}$ , $I_D = -1\text{A}$			520	$\text{m}\Omega$
		$V_{\text{GS}} = -2.5\text{V}$ , $I_D = -0.8\text{A}$			700	
		$V_{\text{GS}} = -1.8\text{V}$ , $I_D = -0.5\text{A}$			950	
Forward transconductance (note 2)	$g_{\text{FS}}$	$V_{\text{DS}} = -10\text{V}$ , $I_D = -0.54\text{A}$		1.2		S
Diode forward voltage	$V_{\text{SD}}$	$I_S = -0.5\text{A}$ , $V_{\text{GS}} = 0\text{V}$			-1.2	V
<b>DYNAMIC PARAMETERS (note 4)</b>						
Input capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = -16\text{V}$ , $V_{\text{GS}} = 0\text{V}$ , $f = 1\text{MHz}$		113	170	$\text{pF}$
Output capacitance	$C_{\text{oss}}$			15	25	
Reverse transfer capacitance	$C_{\text{rss}}$			9	15	
<b>SWITCHING PARAMETERS (note 4)</b>						
Turn-on delay time (note 3)	$t_{d(\text{on})}$	$V_{\text{GS}} = -4.5\text{V}$ , $V_{\text{DS}} = -10\text{V}$ , $I_D = -200\text{mA}$ , $R_{\text{GEN}} = 10\Omega$		9		ns
Turn-on rise time (note 3)	$t_r$			5.8		
Turn-off delay time (note 3)	$t_{d(\text{off})}$			32.7		
Turn-off fall time (note 3)	$t_f$			20.3		

SOT723-Package Outline Drawing



Suggested Land Pattern



Symbol	DIMENSIONS			
	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.43	0.50	0.017	0.020
A1	0.00	0.05	0.000	0.002
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
c	0.08	0.15	0.003	0.006
D	1.15	1.25	0.045	0.049
E	1.15	1.25	0.045	0.049
E1	0.75	0.85	0.03	0.033
e	0.8 typ		0.031 typ	
θ	7° REF		7° REF	